

Title (en)

RESISTANCE SPOT WELDING METHOD

Title (de)

WIDERSTANDSPUNKTSCHWEISSVERFAHREN

Title (fr)

PROCÉDÉ DE SOUDAGE PAR POINTS PAR RÉSISTANCE

Publication

**EP 3085485 A4 20170823 (EN)**

Application

**EP 14870854 A 20141218**

Priority

- JP 2013263272 A 20131220
- JP 2014083571 W 20141218

Abstract (en)

[origin: US2016228973A1] By superposing a plurality of steel sheets including a high tensile steel sheet and performing pulsation conduction by an inverter DC type spot welding power supply and controlling the conduction time of the current pulses, intervals of the current pulses, that is, conduction idle time, and weld current applied at the current pulses in a variable manner, the optimum weld conditions are obtained. For resistance spot welding of the hot stamped steel sheet, resistance spot welding with a minimum weld current of a second pulsation step higher than the maximum weld current at a first pulsation step is used to suppress the occurrence of outer spatter and inner spatter and secure a broad suitable current range even if using an inverter DC power supply.

IPC 8 full level

**B23K 11/11** (2006.01); **B23K 11/16** (2006.01); **B23K 11/24** (2006.01)

CPC (source: EP RU US)

**B23K 11/11** (2013.01 - RU US); **B23K 11/15** (2013.01 - EP US); **B23K 11/16** (2013.01 - EP RU US); **B23K 11/163** (2013.01 - US);  
**B23K 11/24** (2013.01 - EP RU US); **B23K 11/241** (2013.01 - EP US)

Citation (search report)

- [Y] US 2013087533 A1 20130411 - HOU WENKAO [US]
- [A] US 2013088037 A1 20130411 - SCHURTER PAUL [CA], et al
- [Y] GB 1023305 A 19660323 - GEN ELECTRIC
- [A] KR 20120001126 A 20120104 - IUCF HYU [KR], et al
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WO2020053734A1; WO2020053735A1; WO2020053736A1; EP3603869A4; KR20210038967A; CN112566745A; KR20210035303A;  
CN112533725A; KR20210032532A; RU2765968C1; DE102022104981A1; US11772184B2; US11919102B2

Designated contracting state (EPC)

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DOCDB simple family (publication)

**US 10406627 B2 20190910; US 2016228973 A1 20160811;** CA 2926914 A1 20150625; CN 105636735 A 20160601; CN 105636735 B 20190507;  
EP 3085485 A1 20161026; EP 3085485 A4 20170823; EP 3085485 B1 20191023; ES 2764835 T3 20200604; JP 6137337 B2 20170531;  
JP WO2015093568 A1 20170323; KR 101887789 B1 20180810; KR 20160045892 A 20160427; MX 2016006347 A 20160801;  
RU 2016124112 A 20180125; RU 2663659 C2 20180808; WO 2015093568 A1 20150625

DOCDB simple family (application)

**US 201415025459 A 20141218;** CA 2926914 A 20141218; CN 201480056857 A 20141218; EP 14870854 A 20141218;  
ES 14870854 T 20141218; JP 2014083571 W 20141218; JP 2015553603 A 20141218; KR 20167007798 A 20141218;  
MX 2016006347 A 20141218; RU 2016124112 A 20141218